

Silicon TVS diodes Array

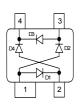
 ESD / transient protection of e.g. ADSL, VDSL, ISDN, WAN, LAN, I²C Bus, Microcontroller Inputs, Video and other high-speed data lines in telecom applications:

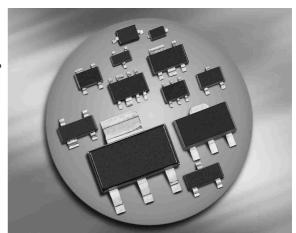
IEC61000-4-2 (ESD): \pm 15 kV (Air / Contact) IEC61000-4-4 (EFT): 4 kV / 80 A (5/50 ns) IEC61000-4-5 (Lightning): 27 A (8/20 μ s)

- Very low capacitance
- Extremly low reverse current < 5 nA
- Pb-free (RoHS compliant) package



DSL70





Туре	Package	Configuration	Marking
DSL70	SOT143	2 channel, rail to rail	E4s

Maximum Ratings at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
ESD contact discharge per diode ¹⁾	V_{ESD}	15	kV
Peak pulse current ($t_p = 8 / 20 \mu s)^2$)	I _{pp}	27	А
Peak pulse power ($t_p = 8 / 20 \mu s$)	P_{pk}	245	W
Operating temperature range	Top	-55125	°C
Storage temperature	$T_{ m stg}$	-65150	

1

2011-06-17

 $^{^{1}}V_{\text{ESD}}$ according to IEC61000-4-2

 $^{^2}I_{pp}$ according to IEC61000-4-5



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values		Unit	
		min.	typ.	max.	
Characteristics -	,	•	,		•
Reverse working voltage	V_{RWM}	-	-	50	V
Reverse current	I _R	-	-	5	nA
$V_{R} = 50 \text{ V}$					
Forward clamping voltage ¹⁾	V _{FC}				V
$I_{PP} = 1 \text{ A}, t_P = 8/20 \mu\text{s}$		-	1	1.5	
I_{PP} = 10 A, t_{P} = 8/20 µs		-	2.5	3	
$I_{PP} = 24 \text{ A}, t_{P} = 8/20 \mu\text{s}$		-	5	6	
$I_{PP} = 27 \text{ A}, t_{P} = 8/20 \mu\text{s}$		-	6	9	
Diode capacitance	СТ				pF
V_{R} = 0 V, f = 1 MHz, between I/0 and GND		-	2.5	5	
$V_R = 0 \text{ V}, f = 1 \text{ MHz}, \text{ between I/0 pins}$		-	1.25	2.5	

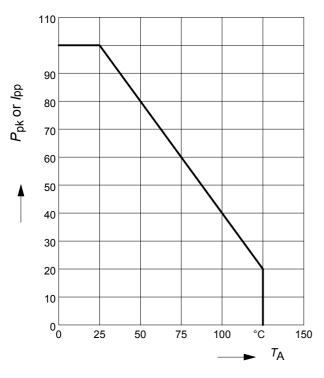
2

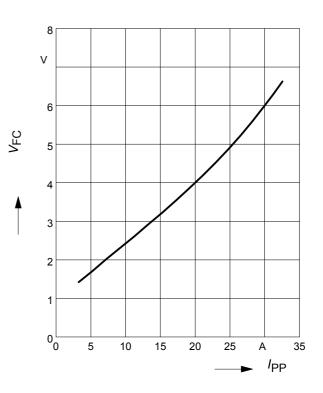
 $^{^{1}}I_{\mathrm{PP}}$ according to IEC61000-4-5



Power derating curve $P_{pk} = f(T_A)$

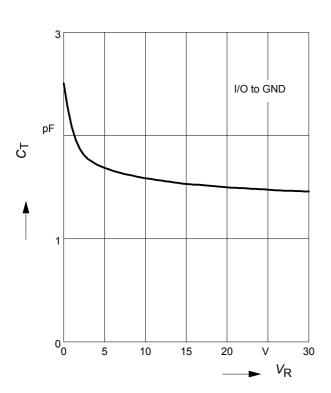
Forward clamping voltage V_{FC} = $f(I_{PP})$ t_p = 8 / 20 µs





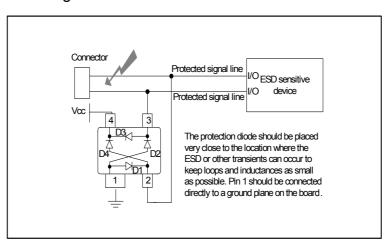
Diode capacitance $C_T = f(V_R)$

f = 1MHz





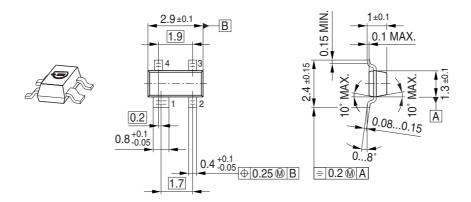
Application example DSL70 dual channel, rail to rail configuration



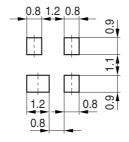
4 2011-06-17



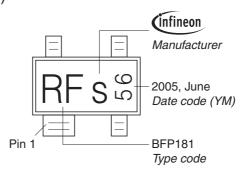
Package Outline



Foot Print

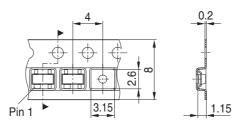


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



5



Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<www.infineon.com>).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

6

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:
DSL70 E6327